

Low Noise Silicon Bipolar RF Transistor

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 20 mA to 80 mA
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- Power amplifier for DECT and PCN systems
- f_T = 7.5 GHz, NF_{min} = 1.3 dB at 900 MHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type / Ordering code	Marking	Pin Configuration						Package
BFP196W / BFP196WH6327XTSA1	RIs	1 = E	2 = C	3 = E	4 = B	-	-	SOT343

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	12	V
Collector-emitter voltage	V _{CES}	20	
Collector-base voltage	V _{CBO}	20	
Emitter-base voltage	V _{EBO}	2	
Collector current	I _C	150	mA
Base current	I_{B}	15	
Total power dissipation ¹⁾	P _{tot}	700	mW
_ <i>T</i> _S ≤ 69°C			
Junction temperature	T_{J}	150	°C
Ambient temperature	T_{A}	-65 150	
Storage temperature	T_{Stg}	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R _{thJS}	115	K/W

 $^{^1}T_{
m S}$ is measured on the collector lead at the soldering point to the pcb

 $^{^2}$ For the definition of R_{thJS} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	•			•	
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0	, ,				
Collector-emitter cutoff current	I _{CES}	-	-	100	μΑ
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	_	1	μΑ
$V_{\rm EB}$ = 1 V, $I_{\rm C}$ = 0					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, pulse measured					

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Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Electrical Characteristics at $T_A = 25$ °C, unless Parameter	Symbol		Unit		
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	,		,	
Transition frequency	f _T	5	7.5	-	GHz
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.86	1.3	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.4	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	3.9	-	
$V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0$,					
collector grounded					
Minimum noise figure	NF _{min}				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
f = 900 MHz		-	1.3	-	
f = 1.8 GHz		-	2.3	-	
Power gain, maximum available ¹⁾	G _{ma}				
I_{C} = 50 mA, V_{CE} = 8 V, Z_{S} = Z_{Sopt} , Z_{L} = Z_{Lopt} ,					
f = 900 MHz		-	19	-	
f = 1.8 GHz		-	12.5	-	
Transducer gain	$ S_{21e} ^2$				dB
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 900 MHz		-	13	-	
f = 1.8 GHz		-	7	-	
Third order intercept point at output ²⁾	IP ₃	-	32	-	dBm
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 0.9 GHz					
1dB Compression point at output	P _{-1dB}	-	19	-	
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 0.9 GHz					

 $^{^{1}}G_{\text{ma}} = |S_{21} / S_{12}| (k-(k^{2}-1)^{1/2})$

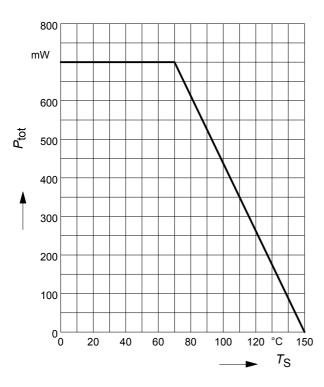
²IP3 value depends on termination of all intermodulation frequency components.

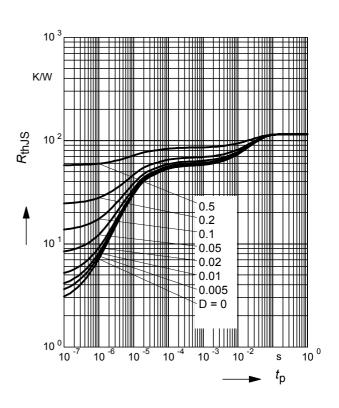
Termination used for this measurement is 50Ω from 0.2 MHz to 12 GHz



Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$

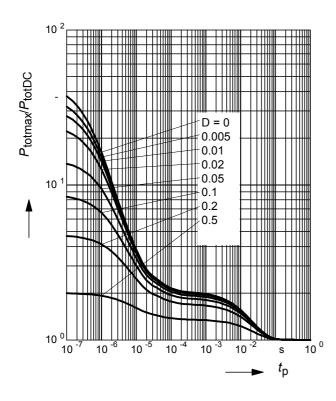
Permissible Pulse Load $R_{thJS} = f(t_p)$





Permissible Pulse Load

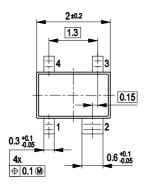
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$$

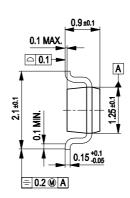




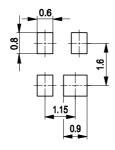
Package Outline



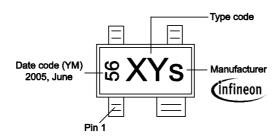




Foot Print

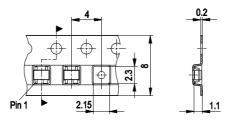


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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